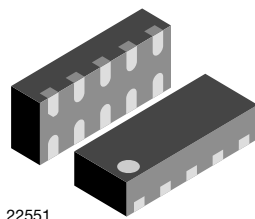
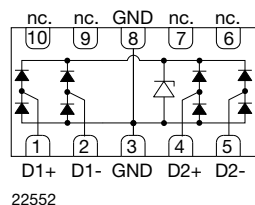


4-Line BUS-Port ESD Protection - Flow Through Design



MARKING (example only)



Dot = pin 1 marking

YY = type code (see table below)

XX = date code

FEATURES

- Compact LLP2510-10L package
- Low package height < 0.6 mm
- 4-line ESD-protection
- Low leakage current $I_R < 0.1 \mu A$
- Low capacitance between I/O lines: 0.3 pF
- Ideal for high speed data line like
 - HDMI, DisplayPort, eSATA
 - USB, 1394/firewire
 - Thunderbolt
- ESD-protection acc. IEC 61000-4-2
 - ± 15 kV contact discharge
 - ± 15 kV air discharge
- Soldering can be checked by standard vision inspection. No X-ray necessary
- e4 - precious metal (e.g. Ag, Au, NiPd, NiPdAu) (no Sn)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

ORDERING INFORMATION

DEVICE NAME	ORDERING CODE	TAPED UNITS PER REEL (8 mm TAPE ON 7" REEL)	MINIMUM ORDER QUANTITY
VBUS54ED-FBL	VBUS54ED-FBL-G4-08	3000	15 000

PACKAGE DATA

DEVICE NAME	PACKAGE NAME	TYPE CODE	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS
VBUS54ED-FBL	LLP2510-10L	L5	3.9 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals

ABSOLUTE MAXIMUM RATINGS VBUS54ED-FBL

PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT
Peak pulse current	Acc. IEC 61000-4-5; $t_p = 8/20 \mu s$; single shot	I_{PPM}	2	A
Peak pulse power	Acc. IEC 61000-4-5; $t_p = 8/20 \mu s$; single shot	P_{PP}	25	W
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses	V_{ESD}	± 15	kV
	Air discharge acc. IEC 61000-4-2; 10 pulses		± 15	
Operating temperature	Junction temperature	T_J	-40 to +125	°C
Storage temperature		T_{STG}	-55 to +150	°C

ELECTRICAL CHARACTERISTICS VBUS54ED-FBL (pin 1, 2, 4 or 5 to pin 3) ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	$N_{channel}$	-	-	4	lines
Reverse stand-off voltage	Max. reverse working voltage	V_{RWM}	-	-	5.5	V
Reverse voltage	at $I_R = 0.1\text{ }\mu\text{A}$	V_R	5.5	-	-	V
Reverse current	at $V_{RWM} = 5.5\text{ V}$	I_R	-	0.02	0.1	μA
Reverse breakdown voltage	at $I_R = 1\text{ mA}$	V_{BR}	6.9	7.5	8.7	V
Reverse clamping voltage	at $I_{PP} = 1\text{ A}$	V_C	-	9.1	11	V
	at $I_{PP} = I_{PPM} = 2\text{ A}$	V_C	-	10.3	12.5	V
Forward clamping voltage	at $I_{PP} = 1\text{ A}$	V_F	-	1.9	2.2	V
	at $I_{PP} = 2\text{ A}$	V_F	-	2.5	3.1	V
Capacitance	at $V_R = 0\text{ V}$; $f = 1\text{ MHz}$	C_D	-	0.7	0.8	pF
	at $V_R = 3.3\text{ V}$; $f = 1\text{ MHz}$		-	0.6	0.8	pF
Capacitance between I/O lines	at $V_R = 3.3\text{ V}$; $f = 1\text{ MHz}$	C_{DD}	-	0.3	0.4	pF

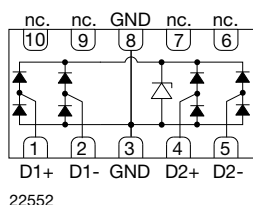
APPLICATION NOTE

The **VBUS54ED-FBL** is a four-line ESD-protection device with the characteristic of a Z-diode with a high ESD-immunity and a very low capacitance which makes it usable for high frequency applications like USB2.0, USB3.0 or HDMI.

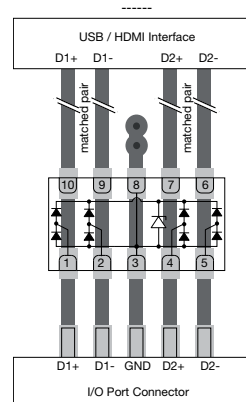
With the **VBUS54ED-FBL** four high speed data lines can be protected against transient voltage signals like ESD (Electro Static Discharge). Connected to the data line (pin 1, 2 and pin 4, 5) and to ground (pin 3 and 8) negative transients will be clamped close below the ground level while positive transients will be clamped close above the 5.5 V working range. The clamping behaviour of the **VBUS54ED-FBL** is bidirectional but asymmetrical (**BiAs**) and so it offers the best protection for applications running up to 5.5 V.

Pin configuration:

- Pin 3 and 8 are internally shorted and have to be connected to ground
- Pin 1, 2 and 4, 5 are the inputs for the data lines D_{1+} and D_{1-} and D_{2+} and D_{2-} .
- Pin 6, 7 and 9, 10 are not connected internally



22552



22553

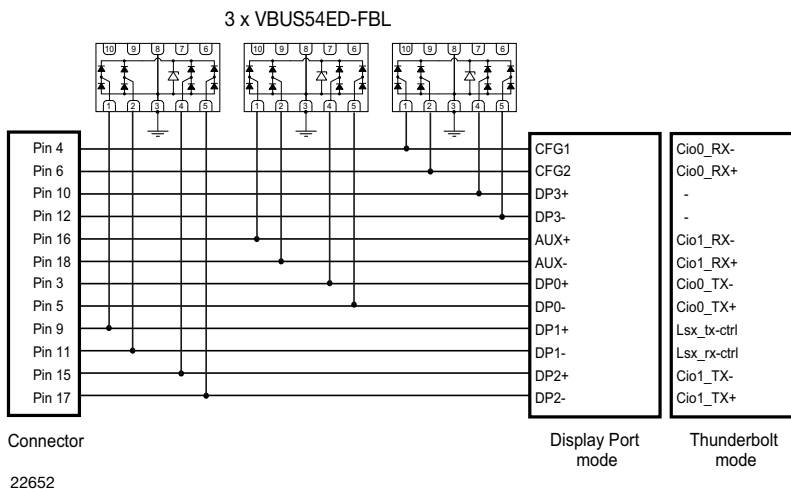
FLOW THROUGH DESIGN

Modern digital transmission lines can be clocked up to 480 Mbit/s (USB2.0) or 1.65 Gbit/s (HDMI).

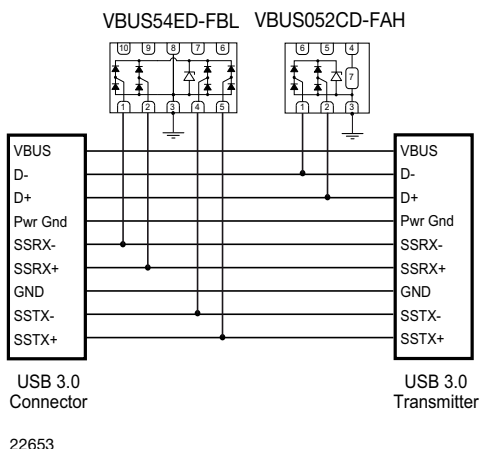
At such high data rates the transmission lines like cables or the line traces on the PCBs have to be very homogeneous regarding their surge impedance. This requires well defined trace dimensions as trace width and distance which have to be calculated depending on the requested surge impedance (e.g. $50\text{ }\Omega$) and the PCB material and layer dimensions. Any device connected to the data lines - like ESD-protection devices - have to be connected with minimal changes in these trace dimensions and distances.

With the package in the so called "Flow Through Design" this is possible. The lines are running straight along the PCB while the **VBUS54ED-FBL** is placed on top without any vias or loops.

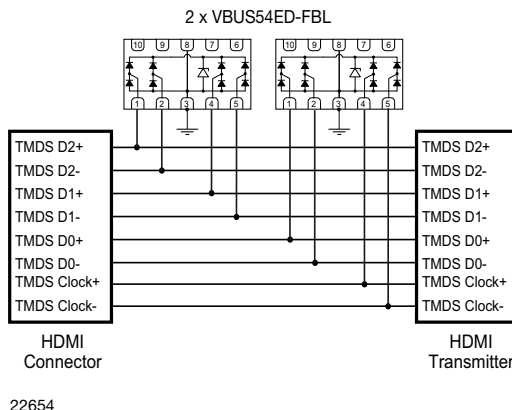
CONNECTION DIAGRAM EXAMPLE FOR THUNDERBOLT DATA PORT



CONNECTION DIAGRAM EXAMPLE FOR USB 3.0 DATA PORT



CONNECTION DIAGRAM EXAMPLE FOR HDMI DATA PORT



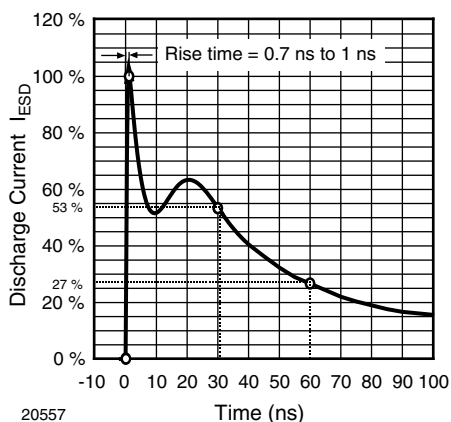
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - ESD Discharge Current Wave Form
acc. IEC 61000-4-2 (330 Ω /150 pF)

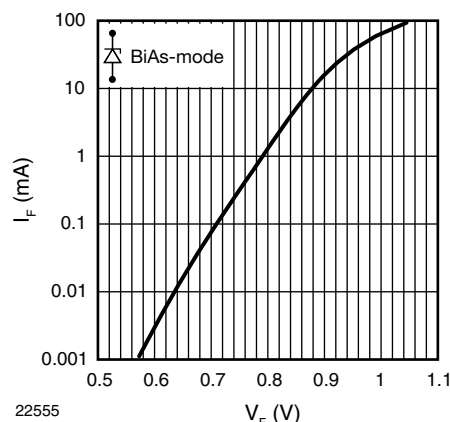


Fig. 4 - Typical Forward Current I_F vs. Forward Voltage V_F

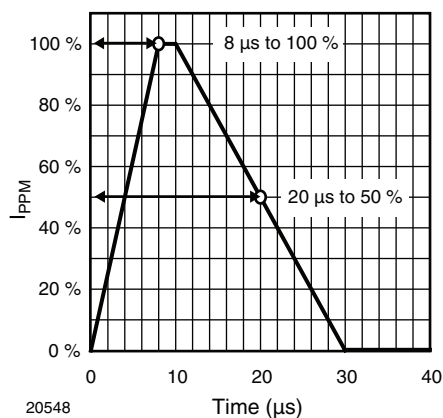


Fig. 2 - 8/20 μ s Peak Pulse Current Wave Form
acc. IEC 61000-4-5

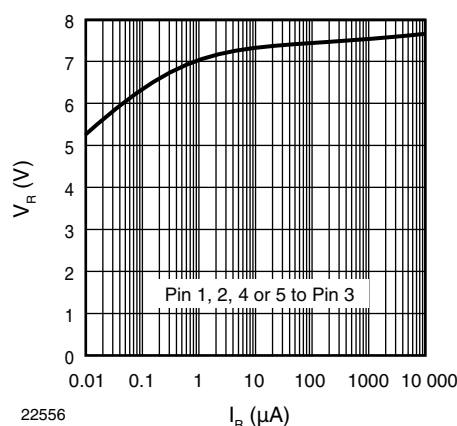


Fig. 5 - Typical Reverse Voltage V_R vs.
Reverse Current I_R

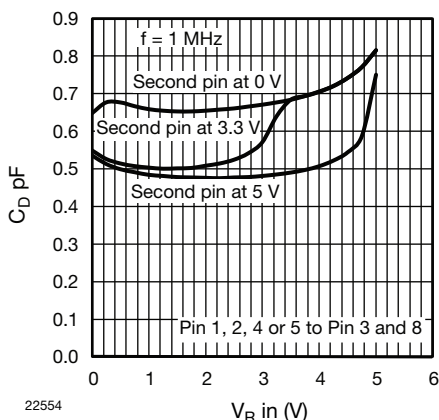


Fig. 3 - Typical Capacitance C_D vs. Reverse Voltage V_R

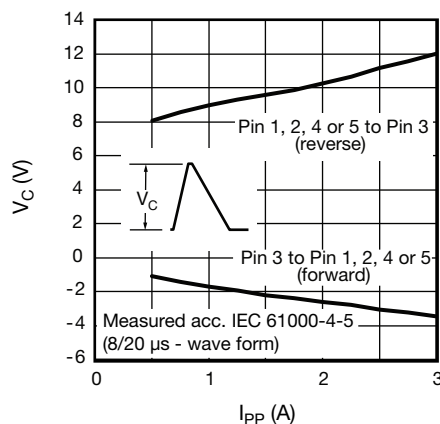


Fig. 6 - Typical Peak Clamping Voltage V_C vs.
Peak Pulse Current I_{PP}

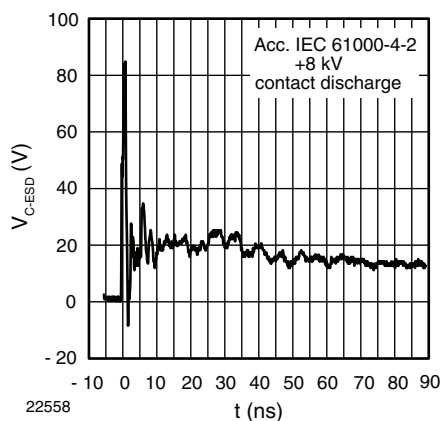


Fig. 7 - Typical Clamping Performance at 8 kV Contact Discharge (acc. IEC 61000-4-2)

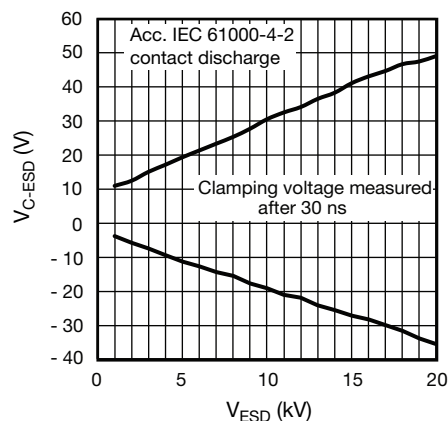


Fig. 9 - Typical Peak Clamping Voltage at ESD Contact Discharge (acc. IEC 61000-4-2)

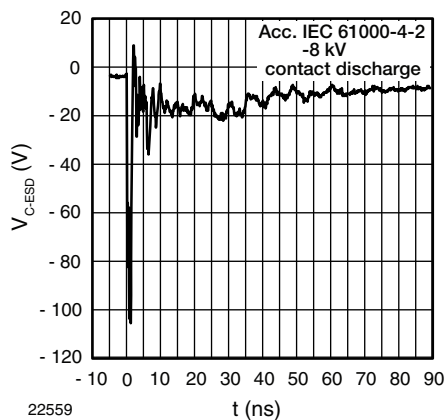
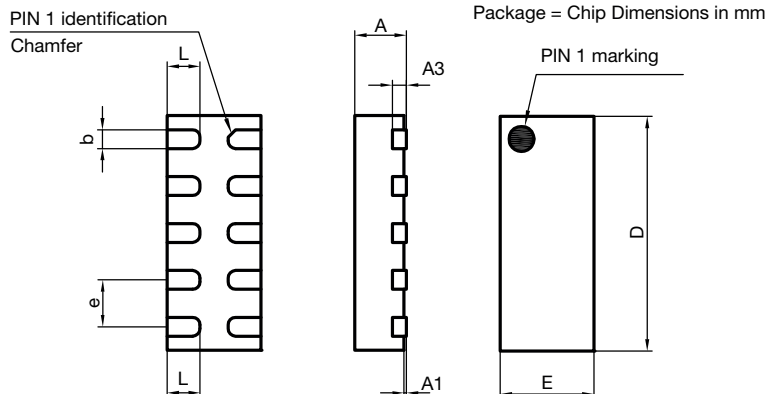
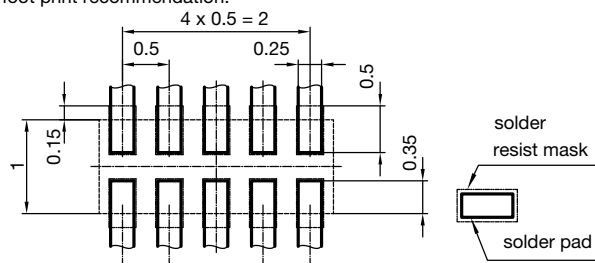


Fig. 8 - Typical Clamping Performance at 8 kV Contact Discharge (acc. IEC 61000-4-2)

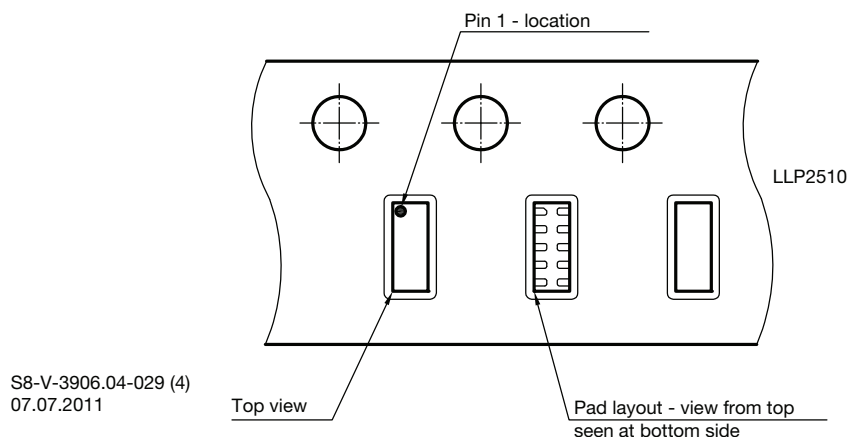
PACKAGE DIMENSIONS in millimeters: **LLP2510-10L**


	Millimeters		
	min.	nom.	max.
A	0.50	0.55	0.60
A1	0.00	-	0.05
A3	-	0.15	-
D	2.45	2.50	2.55
E	0.95	1.00	1.05
b	0.15	0.20	0.25
L	0.30	0.35	0.40
e	-	0.50	-

foot print recommendation:



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22587



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07.07.2011



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